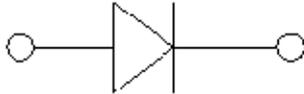


Schottky Rectifier



Features

- V_R 80V
- I_{FAV} 0.5A

Mechanical Data

- **Package:** SOD123
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end
- **Marking:** R8

■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	V	80
DC Blocking Voltage	V_R	V	80
Peak forward surge current (8.3ms, half sine)	I_{FSM}	A	5.5
Average forward current	I_{FAV}	A	0.5
Power dissipation	P_D	mW	410
Thermal Resistance Junction to Ambient Air	$R_{\theta JA}$	°C/W	244
Maximum junction temperature	T_j	°C	-55 to +125
Storage temperature range	T_{stg}	°C	-55 to +125

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

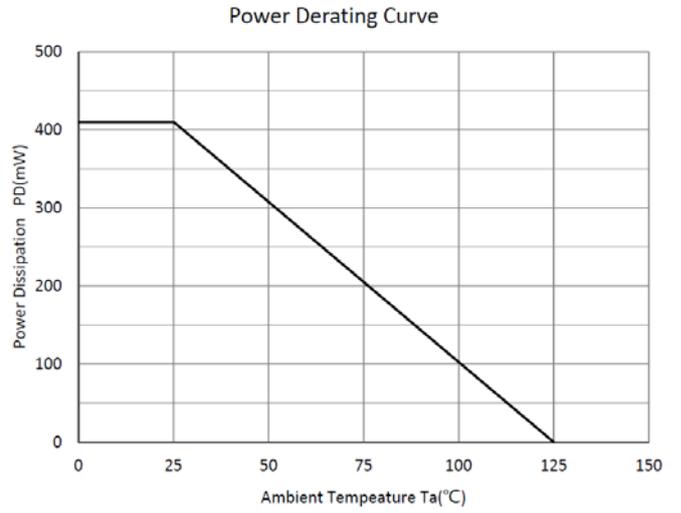
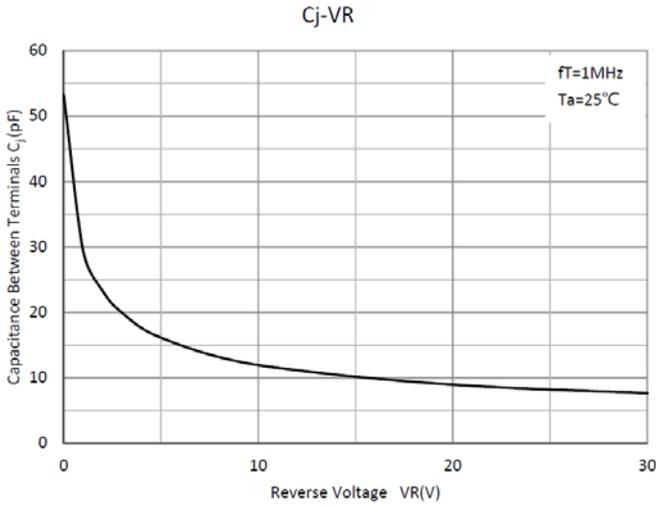
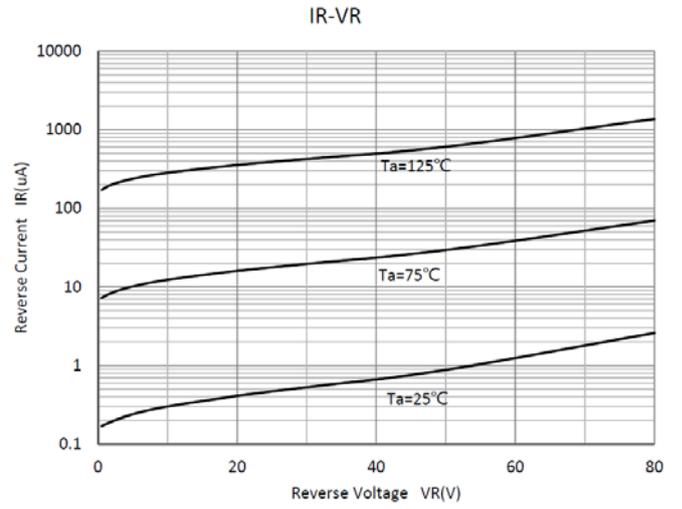
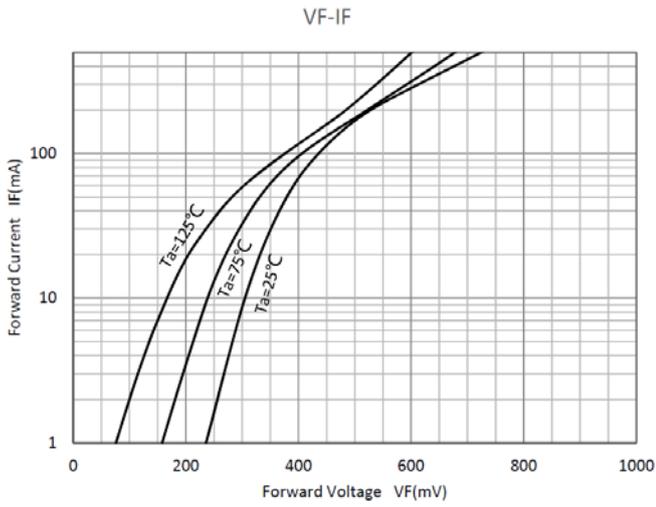
PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Breakdown Voltage	V_R	V	$I_R=100\mu A$	80		
Forward Voltage	V_F	V	$I_F=0.5A$			0.8
Reverse Leakage Current	I_R	mA	$V_R=80V$			0.2
Typical Junction Capacitance	C_J	pF	$V_R=4V, f=1MHz$			30

■Ordering Information (Example)

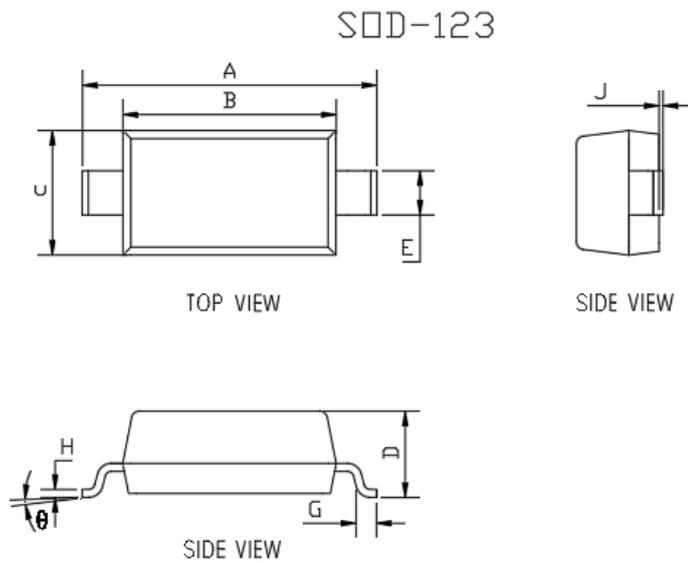
PREFERRED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
MBR0580	F2	Approximate 0.011	3000	30000	120000	7" reel



■ Characteristics (Typical)

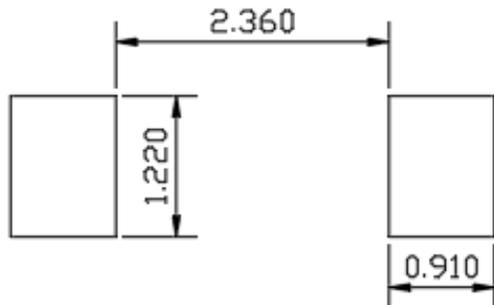


■ Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.140	0.152	3.550	3.850
B	0.100	0.112	2.550	2.850
C	0.055	0.071	1.400	1.800
D	0.037	0.053	0.950	1.350
E	0.020	0.028	0.510	0.710
G	0.006	0.018	0.150	0.450
H	0.003	0.010	0.080	0.250
J	0.000	0.006	0.000	0.150
θ	0	8°	0	8°

■ Soldering Footprint



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT

Note:

- All dimensions are in millimeters (mm) unless otherwise specified.
[所有尺寸均以毫米为单位, 除非另有说明]
- General tolerances: $\pm 0.10\text{mm}$ unless otherwise specified.
[通用公差为 $\pm 0.10\text{mm}$, 除非另有说明]
- Dimensions and tolerances per ASME Y14.5M-2018.
[尺寸和公差遵循 ASME Y14.5M-2018 标准]
- All dimensions shown are exclusive of burrs and gate residues.
Burrs and gate vestiges shall not exceed 0.15 mm in maximum.
[所有尺寸均不包括毛刺和浇口残留。毛刺与浇口残留的尺寸最大不得超过 0.15mm]
- Dimension b does not include dambar protrusion of max 0.100 mm per side.
[尺寸b不包括单边最大0.100 mm的中筋凸出部分]
- Dimensions B and C are the overall extreme outer dimensions of the mold compound. These dimensions exclude mold flash, lead flash, protrusions and burrs but include the maximum allowable mold mismatch.
[B和C是塑封体的外部极限尺寸, 不包括包封溢料、内引线溢料、凸出部分以及胶体毛刺, 但是包含了包封错位的最大尺寸]
- Formed leads shall be planar with respect to one another within a maximum of 0.076 mm relative to the seating plane.
[成型的管脚应为同一平面, 共面性最大为0.1mm]



MBR0580

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